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Vishay Siliconix

Automotive N-Channel 200 V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | | |
|---|--------|--|--|--|--|
| V _{DS} (V) | 200 | | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.035 | | | | |
| I _D (A) | 60 | | | | |
| Configuration | Single | | | | |
| Package | TO-263 | | | | |



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- AEC-Q101 qualified d
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



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| N-Channel MOSFET | ó S |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|---|-----------------------------------|------------------|------|----|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | | V_{DS} | 200 | V | |
| Gate-Source Voltage | | V_{GS} | ± 20 | V | |
| Continuous Drain Current | T _C = 25 °C | I_ | 60 | | |
| Continuous Drain Current | T _C = 125 °C | · I _D | 35 | | |
| Continuous Source Current (Diode Conduction) | Is | 120 | Α | | |
| Pulsed Drain Current ^b | I _{DM} | 100 | | | |
| Single Pulse Avalanche Current L = 0.1 mH | | I _{AS} | 26 | | |
| Single Pulse Avalanche Energy | | E _{AS} | 33 | mJ | |
| Maximum Power Dissipation ^b | T _C = 25 °C | P _D | 375 | W | |
| Maximum Fower Dissipation | T _C = 125 °C | | 125 | VV | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | -55 to +175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--|------------|-------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Junction-to-Ambient PCB Mount ^c | | R_{thJA} | 40 | °C/W | | |
| Junction-to-Case (Drain) | | R_{thJC} | 0.4 | C/VV | | |

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.



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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | |
|---|---------------------|--|---|------|-------|-------|------|--|
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 μA | 200 | - | - | V | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μA | 2.5 | 3.0 | 3.5 | \ \ | |
| Gate-Source Leakage | I _{GSS} | V _{DS} = | 0 V, V _{GS} = ± 20 V | - | - | ± 100 | nA | |
| | | V _{GS} = 0 V | V _{DS} = 200 V | - | - | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V | V _{DS} = 200 V, T _J = 125 °C | - | - | 75 | μA | |
| | | V _{GS} = 0 V | V _{DS} = 200 V, T _J = 175 °C | - | - | 2 | mA | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 \text{ V}$ | 60 | - | - | Α | |
| | | V _{GS} = 10 V | I _D = 20 A | - | 0.028 | 0.035 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 20 A, T _J = 125 °C | - | - | 0.074 | | |
| | | V _{GS} = 10 V | I _D = 20 A, T _J = 175 °C | - | - | 0.098 | 1 | |
| Forward Transconductance b | 9 _{fs} | V _{DS} | V _{DS} = 15 V, I _D = 20 A | | 67 | - | S | |
| Dynamic ^b | | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 4655 | 5850 | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | $V_{GS} = 0 \text{ V}$ $V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 410 | 550 | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 195 | 250 | | |
| Total Gate Charge ^c | Qg | | | - | 90 | 135 | | |
| Gate-Source Charge c | Q_{gs} | V _{GS} = 10 V | $V_{DS} = 100 \text{ V}, I_{D} = 9 \text{ A}$ | - | 16 | 1 | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | - | 29 | 1 | | |
| Gate Resistance | R_g | | f = 1 MHz | | 0.8 | 1.5 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | | 20 | 30 | | |
| Rise Time ^c | t _r | V_{DD} = 100 V, R_L = 11.1 Ω $I_D \cong 9$ A, V_{GEN} = 10 V, R_g = 1 Ω | | - | 40 | 60 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | - | 35 | 53 | 115 | |
| Fall Time ^c | t _f | | | - | 20 | 30 | | |
| Source-Drain Diode Ratings and Characteristics ^b | | | | | | | | |
| Pulsed Current ^a | I _{SM} | | | - | - | 100 | Α | |
| Forward Voltage | V _{SD} | I _F = 30 A, V _{GS} = 0 V | | - | 0.8 | 1.5 | V | |

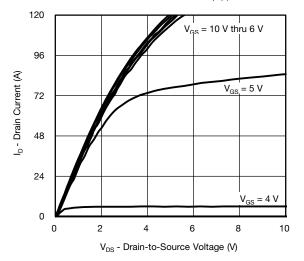
Notes

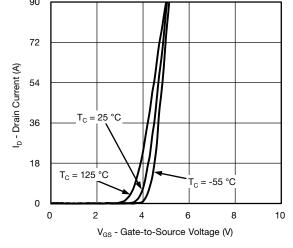
- a. Pulse test; pulse width $\leq 300~\mu s,\,duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



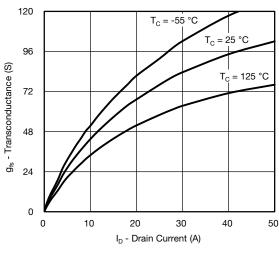
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

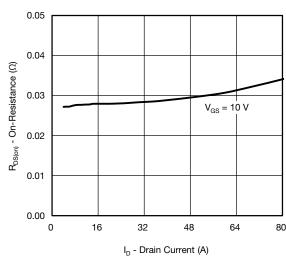




Output Characteristics

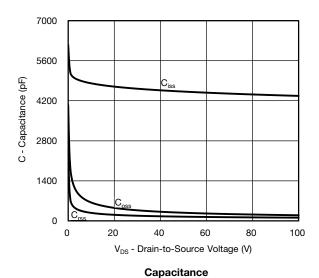


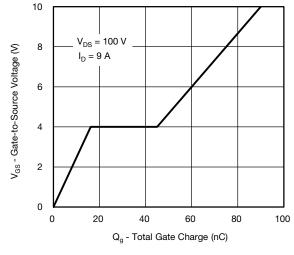




Transconductance

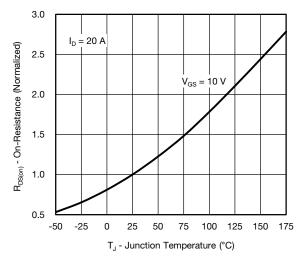
On-Resistance vs. Drain Current

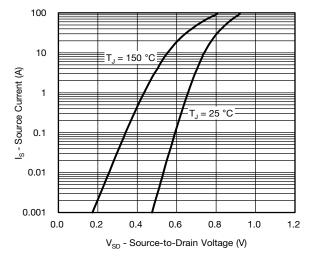




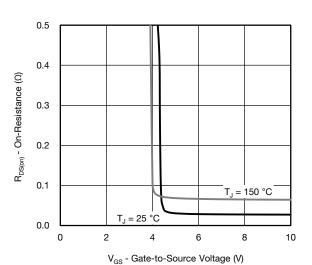


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

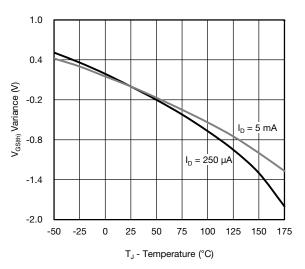




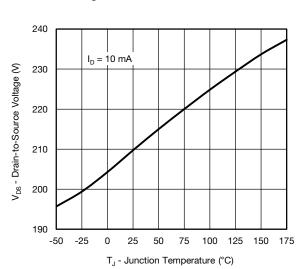
On-Resistance vs. Junction Temperature



Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

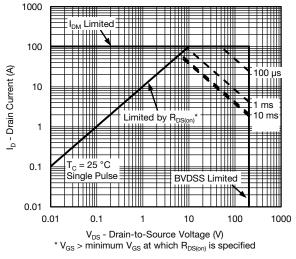


Threshold Voltage

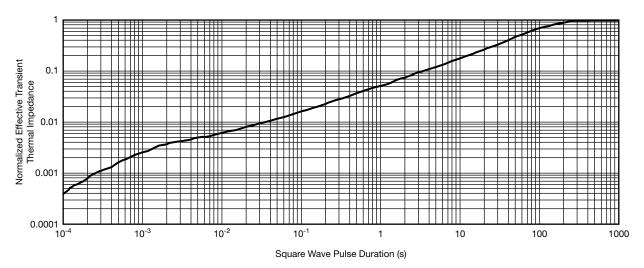
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



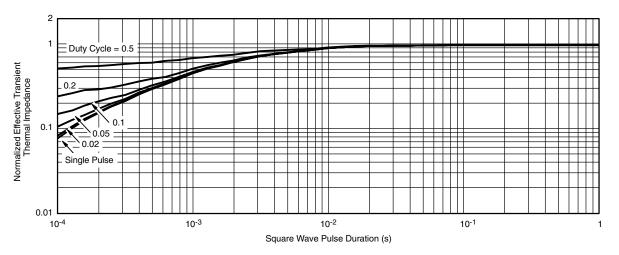
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg262744



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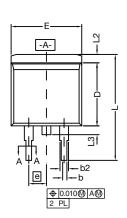
| REVISION HISTORY ^a | | | | |
|-------------------------------|-----------|--------------------------------------|--|--|
| REVISION | DATE | DESCRIPTION OF CHANGE | | |
| В | 04-Aug-15 | Revised R _g minimum limit | | |

Note

a. As of April 2014



TO-263 (D²PAK): 3-LEAD

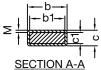








DETAIL A (ROTATED 90°)



| ⋝: | b b1 | ţ |
|----|-------------|---|
| 2: | T /////// 5 | |
| | SECTION A. | Ţ |

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

| | | INC | HES | MILLIMETERS | | |
|---------------------------------|------------|-----------|-------|-------------|--------|--|
| | DIM. | MIN. | MAX. | MIN. | MAX. | |
| | Α | 0.160 | 0.190 | 4.064 | 4.826 | |
| | b | 0.020 | 0.039 | 0.508 | 0.990 | |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| c* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 | |
| C | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 | |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 | |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 | |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D | 0.340 | 0.380 | 8.636 | 9.652 | |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 | |
| | D3 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 | |
| | Е | 0.380 | 0.410 | 9.652 | 10.414 | |
| | E1 | 0.245 | - | 6.223 | = | |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 | |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 | |
| | е | 0.100 |) BSC | 2.54 BSC | | |
| K | | 0.045 | 0.055 | 1.143 | 1.397 | |
| L | | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 | | 0.050 | 0.070 | 1.270 | 1.778 | |
| | L4 | 0.010 BSC | | 0.254 BSC | | |
| | М | - | 0.002 | - | 0.050 | |
| ECN: T13-0707-Rev. K, 30-Sep-13 | | | | | | |

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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